

# Specification for Approval

Date: 2021/08/16

Customer:	天诚科技
TAI-TECH P/N:	TMPA1265SP-100MN-D
CUSTOMER P/N:	
DESCRIPTION:	
QUANTITY:	
QOARTITI:	

REMARK:													
	Customer Approval Feedback												
			I										
	ш,	ᅶᇈ	-	=	<b>4</b> /1	++	DH.	1/1	+	71	71 :		

### 西 北 臺 慶 科 技 股 份 有 限 公司 TAI-TECH Advanced Electronics Co.. Ltd

#### 代理商.

深圳市天诚科技有限公司 Shenzhen TsaSun Technology Co., Ltd. Room 209, 2/F, Block A, Tengfei Industrial Building, No.6, Taohua Road, Futian District, Shenzhen TEL: 0755-8335 8885 / 0755-8335 9885 E-mail: sales@tsasun.com www.tsacoil.com

## □西北臺慶科技股份有限公司

TAI-TECH Advanced Electronics Co., Ltd <u>Headquarter:</u> NO.1 YOU 4TH ROAD, YOUTH INDUSTRIAL DISTRICT, YANG-MEI, TAO-YUAN HSIEN, TAIWAN, R.O.C.

TAU-YUAN HSIEN, TAIWAN, K.O.C. TEL: +886-3-4641148 FAX: +886-3-4643565 http://www.tai-tech.com.tw E-mail: sales@tai-tech.com.tw

## □ 臺慶精密電子(昆山)有限公司

TAI-TECH ADVANCED ELECTRONICS(KUNSHAN) CO., LTD SHINWHA ROAD, KUNJIA HI-TECH INDUSTRIAL PARK, KUN-SHAN, JIANG-SU, CHINA

TEL: +86-512-57619396 FAX: +86-512-57619688

E-mail: hui@tai-tech.com.tw

# Sales Dep.

APPROVED	CHECKED
夏暁曼	夏暁曼

#### **R&D** Center

APPROVED	CHECKED	DRAWN
羅宜春	梁周虎	卜文娟

# **SMD Power Inductor**

TMPA1265SP-100MN-D

#### 1. Features

- 1. Shielded construction.
- 2. Capable of corresponding high frequency .
- 3. Low loss realized with low DCR.
- 4. High performance (Isat) realized by metal dust core.
- 5. Ultra low buzz noise, due to composite construction.
- 6. 100% Lead(Pb)-Free and RoHS compliant.
- 7. Operating temperature -40~+125  $^{\circ}\text{C}\textsc{(Including self temperature rise)}$

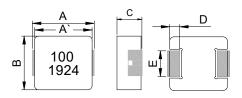
# Halogen Halogen-free



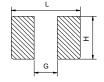
# 2. Applications

- 1. DC/DC converters in distributed power systems.
- 2. DC/DC converter for Field Programmable Gate Array(FPGA).
- 3. Battery powered devices.
- 4. Thin type on-board power supply module for exchanger.
- 5. VRM for server.
- 6. High current, low profile POL converters.
- 7. PDA/notebook/desktop/server and battery powered devices.

# 3. Dimensions







**Recommend PC Board Pattern** 

L(mm)	G(mm)	H(mm)	
14.5	8.0	5.0	
Note: 1. The	e above PCE	3 layout refe	rence only

Recommend solder paste thickness at 0.15mm and above.

 Series
 A
 A^\*
 B
 C
 D
 E

 TMPA1265
 13.5±0.5
 12.6±0.3
 12.6±0.2
 6.2±0.3
 2.3±0.3
 4.7±0.3

Unit:mm

# 4. Part Numbering

TMPA 1265 SP - 100 MN - D

A B C D E F

A: Series

 B: Dimension
 BxC.

 C: Type
 Standard.

 D: Inductance
 100=10.0uH

 E: Inductance Tolerance
 M=±20%

F: Code Marking: Black.100 and 1924(19 YY, 24 WW,follow production date).

# 5. Specification

Part Number	Inductance L0 A(uH)	Carrent Do Carrent Do		Curre	nt DC	DCR (mΩ)	DCR (mΩ)	
	±20%			Max	Тур	Max		
TMPA1265SP-100MN-D	10.0	13	11	17	15	13	15.8	

#### Note:

- 1. Test frequency: Ls: 100KHz /1.0V.
- $3. \ \ Testing\ Instrument (or\ equ): L:\ HP4284A, CH11025, CH3302, CH1320, CH1320S\ LCR\ METER\ /\ Rdc: CH16502, Agilent 33420A\ MICRO\ OHMMETER.$
- 4. Heat Rated Current (Irms) will cause the coil temperature rise approximately  $\,^{\vartriangle}\text{T}$  of 40  $^{\circlearrowright}$
- 5. Saturation Current (Isat) will cause L0 to drop approximately 30%.
- 6. The part temperature (ambient + temp rise) should not exceed 125°Cunder worst case operating conditions. Circuit design, component, PCB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.
- 7. Special inquiries besides the above common used types can be met on your requirement.

# 6. Material List



NO	Items	Materials			
1	Core	Alloy Powder .			
2	Wire	Polyester Wire or equivalent.			
3	Clip	100% Pb free solder(Ni+SnPlating)			
4	Ink	Halogen-free ketone			

# 7. Reliability and Test Condition

Item	Performance	Test Condition
Operating temperature	-40~+125℃ (Including self - temperature rise)	
Storage temperature	110~+40℃,50~60%RH (Product with taping) 240~+125℃(on board)	
Electrical Performance 1	est	
Inductance	Refer to standard electrical characteristics list.	HP4284A,CH11025,CH3302,CH1320,CH1320S LCR Meter.
DCR	Neier to standard electrical dianacteristics list.	CH16502,Agilent33420A Micro-Ohm Meter.
Saturation Current (Isat)	Approximately △L30%.	Saturation DC Current (Isat) will cause L0 to drop $\triangle L(\%)$
Heat Rated Current (Irms)	Approximately △T40°C	Heat Rated Current (Irms) will cause the coil temperature rise △T(ℂ).  1.Applied the allowed DC current 2.Temperature measured by digital surface thermometer
Reliability Test		
Life Test		Preconditioning: Run through IR reflow for 2 times.(IPC/JEDECJ-STD-020DClassification Reflow Profiles) Temperature: 125±2*C(Inductor) Applied current: rated current Duration: 1000±12hrs Measured at room temperature after placing for 24±2 hrs.
Load Humidity		Preconditioning: Run through IR reflow for 2 times.(IPC/JEDECJ-STD-020DClassification Reflow Profiles) Humidity: 85±2 % R.H, Temperature: 85 °C±2 °C Duration: 1000hrs Min. with 100% rated current Measured at room temperature after placing for 24±2 hrs.
Moisture Resistance	Appearance: No damage. Impedance: within±15% of initial value Inductance: within±10% of initial value Q: Shall not exceed the specification value. RDC: within ±15% of initial value and shall not exceed the specification value	Preconditioning: Run through IR reflow for 2 times.(IPC/JEDECJ-STD-020DClassification Reflow Profiles)  1. Baked at50°C for 25hrs, measured at room temperature after placing for 4 hrs.  2. Raise temperature to 65±2°C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25°C in 2.5hrs.  3. Raise temperature to 65±2°C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25°C in 2.5hrs, keep 3 hours, cool down to 25°C in 2.5hrs, keep at 25°C for 2 hrs then keep at -10°C for 3 hrs  4. Keep at 25°C 80-100%RH for 15min and vibrate at the frequency of 10 to 55 Hz to 10 Hz, measure at room temperature after placing for 1~2 hrs.
Thermal shock		Preconditioning: Run through IR reflow for 2 times. (IPC/JEDECJ-STD-020DClassification Reflow Profiles) Condition for 1 cycle  Step1: -40±2℃ 30±5min  Step2: 25±2℃ 50.5min  Step3: 125±2℃ 30±5minNumber of cycles: 500  Measured at room fempraturc after placing for 24±2 hrs.
Vibration		Preconditioning: Run through IR reflow for 2 times.( IPC/JEDECJ-STD-020DClassification Reflow Profiles) Oscillation Frequency: 10~2K~10Hz for 20 minutes Equipment: Vibration checker Total Amplitude:1.52mm±10% Testing Time: 12 hours(20 minutes, 12 cycles each of 3 orientations).

# TAI-TECH

Item	Performance	Test Condition						
Bending	Appearance: No damage.	Shall be mounted on a FR4 substrate of the following dimensions: >=0805 inch(2012mm):40x100x1.2mm <0805 inch(2012mm):40x100x0.8mm Bending depth: >=0805 inch(2012mm):1.2mm <0805 inch(2012mm):0.8mm duration of 10 sec.						
	Impedance: within±15% of initial value Inductance: within±10% of initial value Q: Shall not exceed the specification value. RDC: within ±15% of initial value and shall not	Type Peak Normal Wave value duration (D) (g's) (ms) Wave form (Vi)ft/sec						
Shock	exceed the specification value	SMD 50 11 Half-sine 11.3						
		Lead         50         11         Half-sine         11.3						
Solder ability	More than 95% of the terminal electrode should be covered with solder.	Preheat: 150°C,60sec.。 Solder: Sn96.5% Ag3% Cu0.5% Temperature: 245±5°C。 Flux for lead free: Rosin. 9.5%。 Dip time: 4±1sec. Depth: completely cover the termination						
Resistance to Soldering Heat		Depth: completely cover the termination  Temperature (°C) Time(s) Temperature ramp/immersion and emersion rate Number of heat cycles						
		260 ±5 (solder temp) 10 ±1 25mm/s ±6 mm/s 1						
Terminal Strength	Appearance: No damage. Impedance: within±15% of initial value Inductance: within±10% of initial value Q: Shall not exceed the specification value. RDC: within ±15% of initial value and shall not exceed the specification value e	Preconditioning: Run through IR reflow for 2 times.( IPC/JEDEC J-STD-020DClassification Reflow Profiles With the component mounted on a PCB with the device to be tested, apply a force(-0805:1kg , <=0805:0.5kg)to the side of a device being tested. This force shall be applied for 60 + seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested.						

Note: When there are questions concerning measurement result: measurement shall be made after  $48 \pm 2$  hours of recovery under the standard condition.

# 8. Soldering and Mounting

#### (1) Soldering

Mildly activated rosin fluxes are preferred. The minimum amount of solder can lead to damage from the stresses caused by the difference in coefficients of expansion between solder, chip and substrate. TAI-TECH terminations are suitable for re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

#### (2) Solder re-flow:

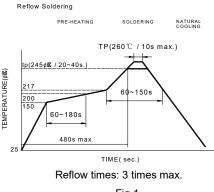
Recommended temperature profiles for re-flow soldering in Figure 1.

#### (3) Soldering Iron:

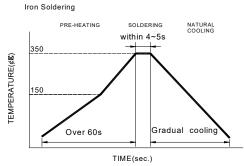
Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended.

- Preheat circuit and products to 150<sup>°</sup>C
- · Never contact the ceramic with the iron tip
- Use a 20 watt soldering iron with tip diameter of 1.0mm

- · 355℃ tip temperature (max)
- 1.0mm tip diameter (max)
- Limit soldering time to 4~5sec.







Iron Soldering times: 1 times max.

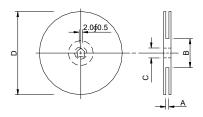
Fig.2

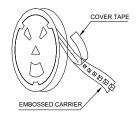
# 9. Friendly reminder

- (1) When there are questions concerning measurement result : measurement shall be made after 48  $\pm$  2 hours of recovery under the standard condition
- (2) This power choke coil itself does not have any protective function in abnormal condition such as overload, short-circuit and open-circuit conditions, etc. Therefore, it shall be confirmed as the end product that there is no risk of smoking, fire, dielectric withstand voltage, insulation resistance, etc. in abnormal conditions to provide protective devices and/or protection circuit in the end product.
- (3) When this power choke coil was used in a similar or new product to the original one, sometimes it might not be able to satisfy the specifications due to different condition of use.
- (4) Dielectric withstanding test with higher voltage than specific value will damage insulating material and shorten its life.
- (5) This power choke coil must not be used in wet condition by water, coffee or any liquid because insulation strength becomes very low in this condition.
- (6) Please consult our company to confirm the reliability of the process required to wash or use or exposure to a chemical solvent used in this product.

# 10. Packaging Information

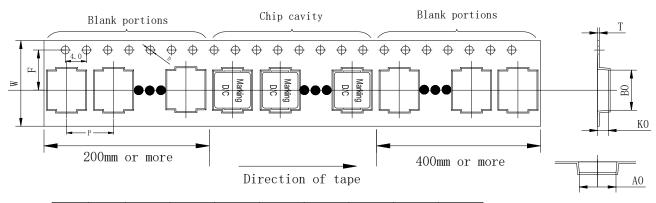
# (1) Reel Dimension





Туре	A(mm)	B(mm)	C(mm)	D(mm)
13"x24mm	24.4+2/-0	100±2	13+0.5/-0.2	330

#### (2) Tape Dimension

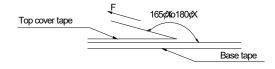


Series	Size	Bo(mm)	Ao(mm)	Ko(mm)	P(mm)	W(mm)	F(mm)	t(mm)	D(mm)
TMPA	1265	14.1±0.1	12.9±0.1	7.0±0.1	16.0±0.1	24±0.3	11.5±0.1	0.35±0.1	1.5±0.1

# (3) Packaging Quantity

TMPA	1265
Chip / Reel	500
Inner box	1000
Carton	4000

## (4) Tearing Off Force



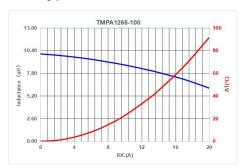
The force for tearing off cover tape is 10 to 130 grams in the arrow direction under the following conditions(referenced ANSI/EIA-481-D-2008 of 4.11 stadnard).

Room Temp.	Room Humidity	Room atm	Tearing Speed
(°C)	(%)	(hPa)	mm/min
5~35	45~85	860~1060	

### **Application Notice**

- · Storage Conditions
- To maintain the solderability of terminal electrodes:
- 1. TAI-TECH products meet IPC/JEDEC J-STD-020D standard-MSL, level 1.
- 3. Recommended products should be used within 12 months form the time of delivery.
- 4. The packaging material should be kept where no chlorine or sulfur exists in the air.
- · Transportation
  - 1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
  - 2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
  - 3. Bulk handling should ensure that abrasion and mechanical shock are minimized.

# 11. Typical Performance Curves



# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Fixed Inductors category:

Click to view products by Tai-Tech manufacturer:

Other Similar products are found below:

CR32NP-100KC 70F224AI MHQ1005P10NJ MHQ1005P1N0S MHQ1005P2N4S MHQ1005P3N6S MHQ1005P5N1S MHQ1005P8N2J PE-53601NL PE-53602NL PG0936.113NLT 9220-20 9310-16 PM06-2N7 PM06-39NJ A01TK 1206CS-471XJ HC2-R47-R HC8-1R2-R HCF1305-3R3-R 1206CS-151XG RCH664NP-4R7M RCP1317NP-391L DH2280-4R7M DS1608C-106 B10TJ B82498B3101J000 ELJ-RE27NJF2 1812CS-153XJ 1812CS-183XJ 1812CS-223XJ 1812LS-104XJ 1812LS-105XJ 1812LS-124XJ 1812LS-154XJ 1812LS-223XJ 1812LS-223XJ 1812LS-224XJ 1812LS-563XJ 1812LS-683XJ 1812LS-824XJ NIN-FB101JTR110F NIN-FB471JTR62F NIN-FC1R5JTR220F NIN-HCR15JTRF NIN-HCR33JTRF NIN-HDR22JTRF NIN-HDR82JTRF NIN-HK2N7STRF NIN-PA150KTR370F NIN-PB100KTR550F